

## Description

Package TO3PF-3L

The FML-4202S is a fast recovery diode of 200 V / 20 A. The maximum  $t_{rr}$  of 40 ns is realized by optimizing a life-time control.

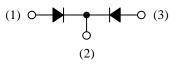
# Features

- V<sub>RM</sub>------ 200 V
- I<sub>F(AV)</sub>------20 A
- V<sub>F</sub>------0.98 V
- t<sub>rr1</sub>------- 40 ns
- Bare lead frame: Pb-free (RoHS compliant)
- Flammability: Equivalent to UL94V-0

# Applications

- Secondary-side Rectifier Diode (Flyback Converter, LLC Converter, etc.)
- Freewheel Diode (Offline Buck Converter, Offline Buck-boost Converter, etc.)

Not to scale



(1) (2) (3)

(1) Anode(2) Cathode(3) Anode

## **Absolute Maximum Ratings**

Parameter	Symbol	Conditions	Rating	Unit
Nonrepetitive Peak Reverse Voltage <sup>(1)</sup>	V <sub>RSM</sub>		200	V
Repetitive Peak Reverse Voltage <sup>(1)</sup>	$V_{RM}$		200	V
Average Forward Current	I <sub>F(AV)</sub>	See Figure 1 and Figure 2	20	А
Surge Forward Current <sup>(1)</sup>	I <sub>FSM</sub>	Half cycle sine wave, positive side, 10 ms, 1 shot	150	А
I <sup>2</sup> t Limiting Value <sup>(1)</sup>	I <sup>2</sup> t	$1 \text{ ms} \le t \le 10 \text{ ms}$	112.5	A <sup>2</sup> s
Junction Temperature	TJ		-40 to 150	°C
Storage Temperature	T <sub>STG</sub>		-40 to 150	°C

#### TT 1

## **Electrical Characteristics**

Unless otherwise specified,  $T_A = 25 \ ^{\circ}C$ . Parameter Symbol Conditions Min. Typ. Max. \_\_\_\_  $T_J = 25 \ ^{\circ}C, I_F = 10 \ A$ 0.98 Forward Voltage Drop<sup>(1)</sup> V<sub>F</sub>  $T_J = 100 \ ^{\circ}C, I_F = 10 A$ 0.80 \_\_\_\_ \_\_\_\_ Reverse Leakage Current<sup>(1)</sup>  $I_{R} \\$  $V_R = V_{RM}$ 10 Reverse Leakage Current  $V_R = V_{RM}, T_J = 150 \ ^{\circ}C$  $H \cdot I_R$ 400 under High Temperature<sup>(1)</sup>  $I_F = I_{RP} = 500 \text{ mA},$ 90% recovery point, 40 t<sub>rr1</sub>  $T_J\,{=}\,25~^\circ C$ Reverse Recovery Time<sup>(1)</sup>  $I_F = 500 \text{ mA}, I_{RP} = 1 \text{ A},$ 75% recovery point, 30 t<sub>rr2</sub>  $T_J = 25 \ ^{\circ}C$ Thermal Resistance<sup>(2)</sup> 2.0

R<sub>th(J-C)</sub>

## **Mechanical Characteristics**

Parameter	Conditions	Min.	Тур.	Max.	Unit
Heatsink Mounting Screw Torque		0.686		0.882	N∙m

Unit

V

V

μA

μA

ns

ns

°C/W

<sup>&</sup>lt;sup>(1)</sup> Specifies a value per chip; the FML-4202S consists of two chips.

 $<sup>^{(2)}</sup>$   $R_{th (J-C)}$  is thermal resistance between junction and the case. The case temperature is measured at the back side near the screw hole.

## **Rating and Characteristic Curves**

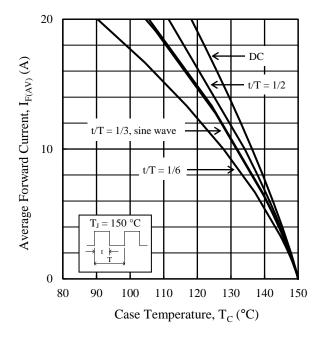


Figure 1. Typical Characteristics:  $I_{F(AV)} \mbox{ vs. } T_C$   $(V_R = 0 \ V)$ 

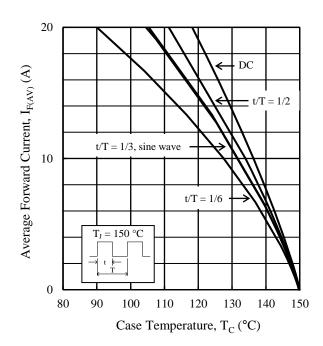


Figure 2. Typical Characteristics:  $I_{F(AV)}$  vs.  $T_C$ ( $V_R = 200 \text{ V}$ )

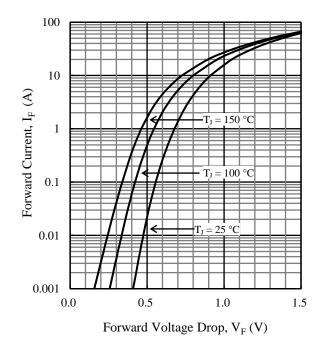
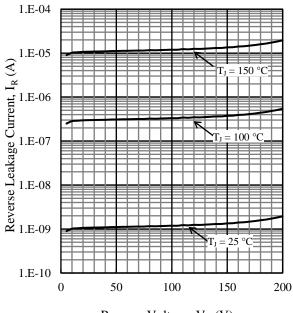


Figure 3. Typical Characteristics: IF vs. VF



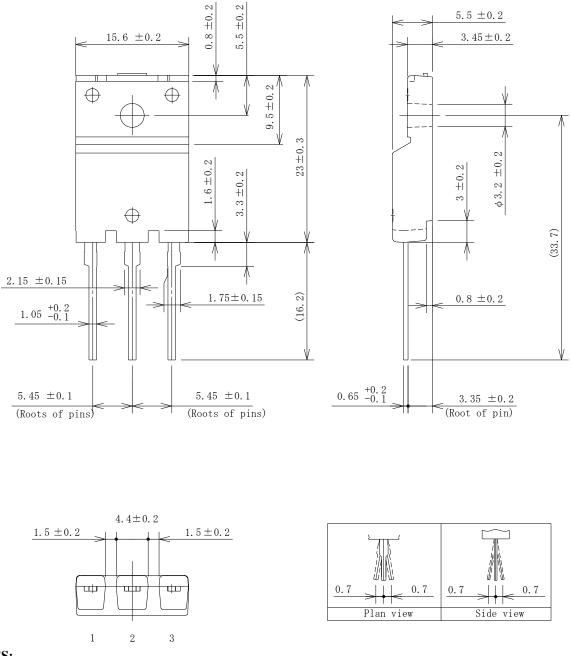
Reverse Voltage,  $V_R(V)$ 

Figure 4. Typical Characteristics:  $I_R$  vs.  $V_R$ 

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## **Physical Dimensions**

### • TO3PF-3L



#### **NOTES:**

- Dimensions in millimeters.
- Maximum gate burr height is 0.3 mm.
- Bare lead frame: Pb-free (RoHS compliant)
- When soldering the products, it is required to minimize the working time within the following limits: Flow: 260 ± 5 °C / 10 ± 1 s, 2 times Soldering Iron: 380 ± 10 °C / 3.5 ± 0.5 s, 1 time
  - Soldering should be at a distance of at least 1.5 mm from the body of the product.

# **Marking Diagram**

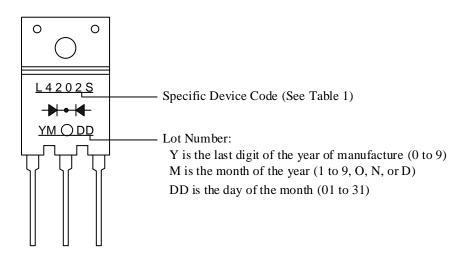


Table 1. Specific Device Code

Specific Device Code	Part Number
L4202S	FML-4202S

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